Amendments to the Claims:

This listing of claims will replace all prior versions and listings of claims in the application.

Listing of Claims:

Claims 1 - 37 (cancelled).

- 1 38. (new) A method of manufacturing a construction
- 2 element made from wood fibers, wood chips and/or sawdust
- 3 comprising the steps of:
- 4 providing said wood fibers, wood chips and/or sawdust,
- applying an adhesive to said wood fibers, wood chips
- 6 and/or sawdust, and
- 7 pressing the wood fibers, wood chips and/or sawdust
- 8 provided with said adhesive to form said construction
- 9 element.
- 1 39. (new) The method of claim 38, wherein the step of
- 2 providing said wood fibers, wood chips and/or sawdust
- 3 includes providing at least some of said wood fibers, wood
- 4 chips and/or sawdust as recycled wood fibers, wood chips
- 5 and/or sawdust from the manufacture of said construction
- 6 elements.

- 1 40. (new) The method of claim 39, further including
- 2 the step of grinding said construction elements following
- 3 said step of pressing, and wherein said recycled wood
- 4 fibers, wood chips and/or sawdust are obtained from said
- 5 grinding step.
- 1 41. (new) The method of claim 38, wherein the step of
- 2 pressing is done at a temperature below 120° C.
- 1 42. (new) The method of claim 38, wherein the step of
- 2 pressing is done at a temperature below 95° C.
- 1 43. (new) The method of claim 38, wherein the step of
- 2 pressing is done at a temperature below 60° C.
- 1 44. (new) The method of claim 38, wherein said
- 2 adhesive includes reactive resins, that may be hardened by
- 3 cross-linking, selected from the group consisting of urea
- 4 resins, melamine resins, acrylic resins, epoxy resins,
- 5 polyester resins and mixtures thereof, and the step of
- 6 pressing said wood fibers, wood chips and/or sawdust is free
- 7 of substantial hardening of said adhesive.

- 1 45. (new) The method of claim 44, wherein said
- 2 construction element comprises from less than about 10% up
- 3 to about 35% adhesive by weight.
- 1 46. (new) The method of claim 44, wherein said wood
- 2 fibers, wood chips and/or sawdust are broken down into solid
- 3 and liquid components within a gas-tight system, the liquid
- 4 components being separated from the solid components at a
- 5 temperature in the range from about less than 50° C up to
- 6 about 90° C, said liquid components being added to said
- 7 adhesive and applied to said solid components to form said
- 8 construction element.
- 1 47. (new) The method of claim 46, wherein said
- 2 adhesive is applied to said wood fibers, wood chips and/or
- 3 sawdust at a temperature less than 100° C.
- 1 48. (new) The method of claim 47, further including
- 2 the step of drying said wood fibers, wood chips and/or
- 3 sawdust in a drying device at a drying temperature, and
- 4 wherein the step of applying adhesive is performed remote of
- 5 said drying device at a temperature cooler then said drying
- 6 temperature.

- 1 49. (new) The method of claim 48, wherein the step of
- 2 applying adhesive includes spraying an adhesive-gas mixture
- 3 onto said wood fibers, wood chips and/or sawdust.
- 1 50. (new) The method of claim 49, wherein said
- 2 adhesive is applied in an amount such that the resulting
- 3 construction element contains from amount 45 kg/m³ to 55
- 4 kg/m^3 of adhesive.
- 1 51. (new) The method of claim 50, wherein the step of
- 2 applying adhesive includes placing said wood fibers, wood
- 3 chips and/or sawdust onto a belt weighing machine and
- 4 maintaining a constant weight ratio of said adhesive applied
- 5 to said wood fibers, wood chips and/or sawdust.
- 1 52. (new) The method of claim 51, wherein said wood
- 2 fibers, wood chips and/or sawdust provided with said
- 3 adhesive are mixed and/or stirred in a cooled wall vessel.
- 1 53. (new) The method of claim 52, wherein the step of
- 2 applying said adhesive includes initially forming a curtain
- 3 or a mat of said wood fibers, wood chips and/or sawdust and
- 4 applying the adhesive to said curtain or mat.

- 1 54. (new) The method of claim 53, further including
- 2 applying air at a temperature of from about 40° C to about
- 3 70° C together with said adhesive to said wood fibers, wood
- 4 chips and/or sawdust.
- 1 55. (new) The method of claim 54, wherein the step of
- 2 applying said adhesive includes also applying a hardening
- 3 agent to said wood fibers, wood chips and/or sawdust.
- 1 56. (new) The method of claim 55, wherein said
- adhesive applied to said wood fibers, wood chips and/or
- 3 sawdust has an outer surface that is hardened by cross-
- 4 linking.
- 1 57. (new) The method of claim 56, further including
- 2 laminating a finishing component to said construction
- 3 element at an elevated temperature and completing the
- 4 hardening by cross-linking of said adhesive.
- 1 58. (new) The method of claim 44, further including
- 2 breaking down said wood fibers, wood chips and/or sawdust
- 3 into solid components and liquid components, adding said
- 4 liquid components to said adhesive, and applying said

- 5 adhesive and liquid components to said wood fibers, wood
- 6 chips and/or sawdust.
- 1 59. (new) The method of claim 58, further including
- 2 cooling said liquid components by at least 30° C and then
- 3 applying the liquid components to said wood fibers, wood
- 4 chips and/or sawdust.
- 1 60. (new) The method of claim 58, wherein said liquid
- 2 components include lignin and hemicellulose, said liquid
- 3 components comprising up to about 20 percent by weight of
- 4 said adhesive.
- 1 61. (new) The method of claim 58, wherein synthetic
- 2 material fibers and/or glass fibers are added to said wood
- 3 fibers, wood chips and/or sawdust.
- 1 62. (new) The method of claim 58, wherein said
- 2 adhesive applied to said wood fibers, wood chips and/or
- 3 sawdust has an outer surface that is hardened by cross-
- 4 linking.

- 1 63. (new) The method of claim 62, wherein said wood
- 2 fibers, wood chips and/or sawdust are charged with steam
- 3 immediately before pressing.
- 1 64. (new) The method of claim 63, wherein said recycled
- 2 wood fibers, wood chips and/or sawdust are obtained from the
- 3 manufacture of MDF and/or HDF boards for flooring panels and
- 4 molded parts.
- 1 65. (new) The method of claim 64, wherein said pressed
- 2 construction element is coated with at least paper provided
- 3 with resins and compressed in a press at temperatures above
- 4 150° C to laminate said paper to said construction element:
- 5 and complete said hardening by cross-linking said adhesive.
- 1 66. (new) A construction element made entirely or
- 2 predominantly from wood fibers, wood chips and/or sawdust
- 3 provided with adhesive and compressed together, said
- 4 construction element containing from about 45 to about 55
- 5 kg/m^3 of said adhesive.
- 1 67. (new) The construction element of claim 66,
- 2 wherein said adhesive comprises non-hardened resins.

- 1 68. (new) The construction element of claim 67,
- 2 wherein said adhesive is selected from the group consisting
- of urea resins, melamine resins, acrylic resins, epoxy
- 4 resins, polyester resins or mixtures of the same.
- 1 69. (new) The construction element of claim 68,
- 2 wherein said construction element is a board.
- 1 70. (new) The construction element of claim 69,
- 2 wherein said board consists essentially of wood fibers
- 3 secured together with said adhesive.
- 1 71. (new) The construction element of claim 68,
- 2 wherein said construction element contains more than 5
- 3 percent by weight of said sawdust.
- 1 72. (new) The construction element of claim 68,
- 2 wherein said construction element has a density of at least
- 3 300 kg/ m^3 .
- 1 73. (new) The construction element of claim 68,
- 2 wherein said construction element has a density of less than
- 3 1500 kg/ m^3 .

- 1 74. (new) A construction element produced in
- 2 accordance with the method of claim 38.
- 1 75. (new) A laminate panel having a plurality of
- 2 layers including a carrier board and one or more paper
- 3 layers, said carrier board being produced in accordance with
- 4 the method of claim 38.
- 1 76. (new) The laminate of claim 75, wherein said
- 2 carrier board has a density greater than 1500 kg/m³.